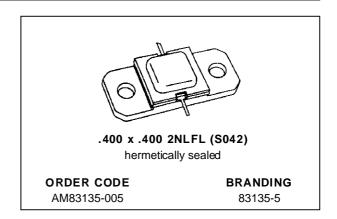


AM83135-005

RF & MICROWAVE TRANSISTORS S-BAND RADAR APPLICATIONS

- REFRACTORY/GOLD METALLIZATION
- EMITTER SITE BALLASTED
- 5:1 VSWR CAPABILITY
- LOW THERMAL RESISTANCE
- INPUT/OUTPUT MATCHING
- OVERLAY GEOMETRY
- METAL/CERAMIC HERMETIC PACKAGE
- P_{OUT} = 5.0 W MIN. WITH 5.2 dB GAIN

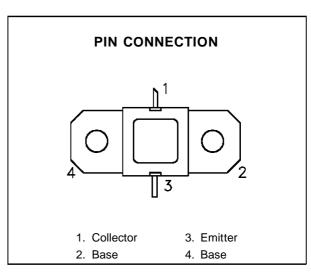


DESCRIPTION

The AM83135-005 device is a medium power silicon bipolar NPN transistor specifically designed for S-Band radar pulsed driver applications.

This device is capable of operation over a wide range of pulse widths. duty cycles and temperatures, and can withstand a 5:1 output VSWR. Low RF thermal resistance, refractory/gold metallization, and computerized automatic wire bonding techniques ensure high reliability and product consistency.

The AM83135-005 is supplied in the AMPAC™ Hermetic Metal/Ceramic package with internal Input/Output matching circuitry, and is intended for military and other high reliability applications.



ABSOLUTE MAXIMUM RATINGS (Tcase = 25°C)

Symbol	Parameter	Value	Unit	
P _{DISS}	Power Dissipation* $(T_C \le 100^{\circ}C)$	40	W	
Ic	Device Current*	1.8	A	
V _{CC}	Collector-Supply Voltage*	34	V	
TJ	Junction Temperature (Pulsed RF Operation)	250	°C	
T _{STG}	Storage Temperature	- 65 to +200	°C	

THERMAL DATA

R _{TH(j-c)} Junction-Case Thermal Resistance* 3.75 °C/W
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^{*}Applies only to rated RF amplifier operation

August 23, 1996

ELECTRICAL SPECIFICATIONS (T_{case} = 25°C)

STATIC

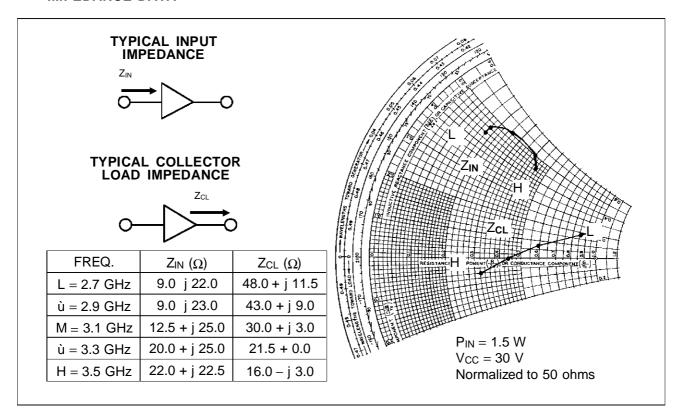
Symbol	Test Conditions	Value			11:4		
	Test Conditions		Min.	Тур.	Max.	Unit	
ВУсво	I _C = 4 mA	$I_E = 0 \text{ mA}$		50	_	_	V
BV _{EBO}	I _E = 2 mA	I _C = 0 mA		3.5	_	_	V
BV _{CER}	I _C = 4 mA	$R_{BE} = 10 \Omega$		50	_	_	V
I _{CES}	V _{CE} = 30 V			_	_	2.0	mA
h _{FE}	V _{CE} = 5 V	I _C = 500 mA		10	_	_	_

DYNAMIC

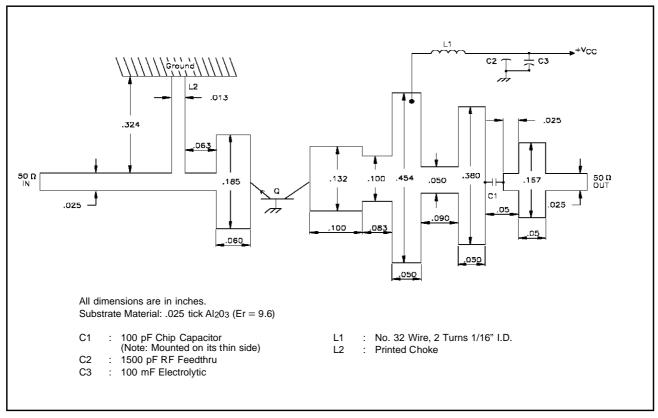
Cumbal	Test Conditions		Value			IIm:4	
Symbol			Min.	Тур.	Max.	Unit	
Pout	f = 3.1 – 3.5 GHz	$P_{IN} = 1.5 \text{ W}$	$V_{CC} = 30 \text{ V}$	5.0	6.0	_	W
hc	f = 3.1 – 3.5 GHz	Pout = 5.0 W	Vcc = 30 V	27	_	_	%
P _G	f = 3.1 – 3.5 GHz	$P_{OUT} = 5.0 \text{ W}$	$V_{CC} = 30 \text{ V}$	5.2	6.4	_	dB

Note: Pulse Width = $100 \mu S$ Duty Cycle = 10%

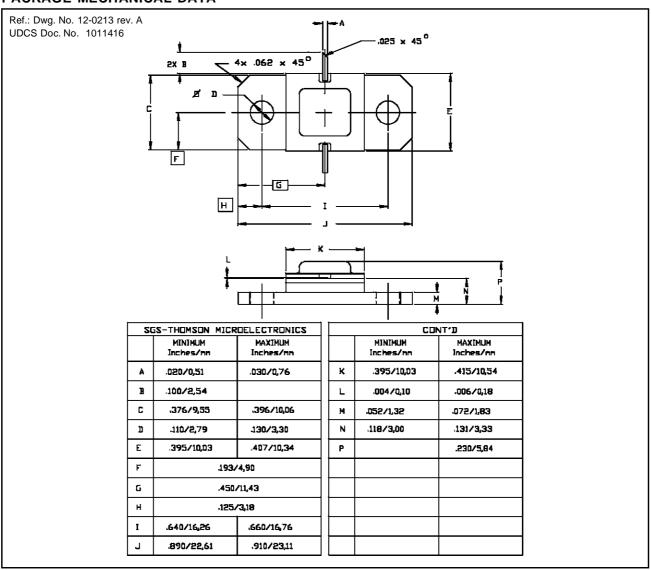
IMPEDANCE DATA



TEST CIRCUIT



PACKAGE MECHANICAL DATA



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